#### 查询UPC8187TB-E3-A供应商

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# SILICON RFIC HI-IP3 FREQUENCY UP-CONVERTER FOR WIRELESS TRANSCEIVER

# **UPC8187TB**

### **FEATURES**

- **HIGH OUTPUT FREQUENCY:** fRFout = 0.8 to 2.5 GHz
- SUPPLY VOLTAGE: Vcc = 2.7 to 3.3 V
- HIGH IP3 AND CONVERSION GAIN:  $OIP_3 = +10 \text{ dBm typ}$  at fRFout = 0.9 GHz CG = +11 dBm typ at fRFout = 0.9 GHz
- HIGH-DENSITY SURFACE MOUNTING: 6-pin super minimold package

### DESCRIPTION

NEC's UPC8187TB is a silicon monolithic integrated circuit designed as a frequency up-converter for wireless transceivers. This IC has higher operating frequency, lower distortion and higher conversion gain than the conventional UPC8163TB. This device is manufactured using NEC's 30 GHz fmax UHS0 (Ultra High Speed Process) silicon bipolar process.

NEC's stringent quality assurance and test procedures ensure the highest reliability and performance.

### ELECTRICAL CHARACTERISTICS

# (Top View) LO input GND Vcc GND RF output IF input

### **APPLICATIONS**

- TDMA, PCS, CDMA
- Digital Cellular/Cordless Phones
- Wireless Tranceivers

			PART NUMBER	EDM			UPC8187TB S06	
SYMBOLS	1 24 55	PARAMET	ERS AND CON	DITIONS <sup>1</sup>	UNITS	MIN	ТҮР	MAX
lcc	Circuit Current (no	signal)			mA	11	15	19
CG1		$f_{RFout} = 0.$	83 GHz, PIFin = -2	20 dBm	dB	8	11	14
CG2	Conversion Gain,	fRFout = 1.	9 GHz, PIFin = -20	0 dBm	dB	8	11	14
CG3		fRFout = 2.	4 GHz, PIFin = -20	0 dBm	dB	7	10	13
PO(SAT)1	fRFout = 0.83			Iz, PIFin = 0 dBm	dBm	+1.5	+4	-
PO(SAT)2	Saturated RF Output Power, fRFout = 1.9 GHz, fRFout = 2.4 GHz,		fRFout = 1.9 GHz	z, PIFin = 0 dBm	dBm	0	+2.5	-
PO(SAT)3			z, PIFin = 0 dBm	dBm	-1.5	+1	-	
	Output Third-Orde	r Distortior	Intercept Point,					
OIP31		fRFout = 0.5	83 GHz	fIFin1 = 150 MHz	dBm	-	10	-
OIP32		fRFout = 1.	9 GHz	flFin2 = 151 MHz	dBm	-	10	-
OIP33	- ab [6]	fRFout = 2.	4 GHz		dBm	-	8.5	-
	Input Third-Order	Distortion I	ntercept Point,					
IIP31	1. C. P	fRFout = 0.8	33 GHz	fIFin1 = 150 MHz	dBm	-	-1.0	-
IIP32	fRFout = 1.9 GHz fi			fIFin2 = 151 MHz	dBm	-	-1.0	-
IIP33	fRFout = 2.4 GHz			dBm	-	-1.5	-	
SSB•NF1	fRFout = 0.83 GHz				dB	-	11	-
SSB•NF2	SSB Noise Figure	, fRFout	= 1.9 GHz	fIFin1 = 150 MHz	dB	_	12	-
SSB•NF3	_	fRFout	= 2.4 GHz		dB	-	12.5	-

### California Eastern Laboratories

### **BLOCK DIGRAM**

### **ABSOLUTE MAXIMUM RATINGS<sup>1</sup>**

 $(T_A = +25^{\circ}C \text{ unless otherwise specified})$ 

SYMBOLS	PARAMETERS	UNITS	RATINGS
Vcc	Supply Voltage	V	3.6
PD	Power Dissipation <sup>2</sup>	mW	270
Та	Operating Ambient Temperature	°C	-40 to +85
Тѕтс	Storage Temperature	°C	-55 to +150
Pin	Maximum Input Power	dBm	+10

Notes:

1. Operation in excess of any one of these conditions may result in permanent damage.

### RECOMMENDED **OPERATING CONDITIONS**

SYMBOLS	PARAMETERS	UNITS	MIN	TYP	MAX
Vcc	Supply Voltage <sup>1</sup>	V	2.7	2.8	3.3
Та	Operating Ambient Temperature	°C	-40	+25	+85
PLOin	Local Input Level <sup>2</sup>	dBm	-10	-5	0
fRFout	RF Output Frequency <sup>3</sup>	GHz	0.8	-	2.5
fIFin	IF Input Frequency	MHz	50	-	400

Notes:

1. Same voltage applied to pins 5 and 6. 2.  $Zs = 50 \Omega$  (without matching).

3. With external matching circuit.

SERIES PRODUCTS <sup>1</sup>	$(T_A = +25^{\circ}C, V_{CC} = V_{PS} = V_{RFout} = 3.0 \text{ V}, Z_S = Z_L = 50 \Omega)$
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Part Number	Icc	fRFout	CG (dB		OIP <sub>3</sub> (dBm)		Po(sat)				
	(mA)	(GHz)	@RF 0.9 GHz <sup>2</sup>	@RF 1.9 GHz	@RF 2.4 GHz	@RF 0.9 GHz <sup>2</sup>	@RF 1.9 GHz	@RF 2.4 GHz	@RF 0.9 GHz <sup>2</sup>	@RF 1.9 GHz	@RF 2.4 GHz
UPC8187TB	15	0.8 to 2.5	11	11	10	+10	+10	+8.5	+4	+2.5	+1
UPC8106TB	9	0.4 to 2.0	9	7	-	+5.5	+2.0	-	-2	-4	-
UPC8172TB	9	0.8 to 2.5	9.5	8.5	8.0	+7.5	+6.0	+4.0	+0.5	0	-0.5
UPC8109TB	5	0.4 to 2.0	6	4	-	+1.5	-1.0	-	-5.5	-7.5	-
UPC8163TB	16.5	0.8 to 2.0	9	5.5	-	+9.5	+6.0	-	+0.5	-2	-

Notes:

1. Typical performance.

2. fRFout = 0.83 GHz @ UPC8163TB and UPC8187TB.

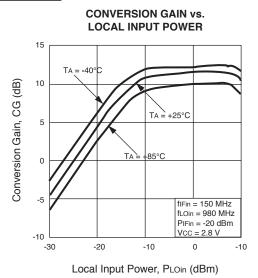
Pin No.	Pin Name	Applied Voltage (V)	Pin Voltage (V)	Function and Explanation	Equivalent Circuit
1	lFinput	_	1.2	This pin is the IF input pin to the double balanced mixer (DBM). The input is designed as a high impedance. The circuit helps suppress spurious signals. Also this symmetrical circuit can keep specified performance insensitive to process- condition distribution. For that reason, a double balanced mixer is adopted.	
2 4	GND	GND	_	GND pin. Ground pattern on the board should be formed as wide as possible. Track length should be kept as short as possible to minimize ground inductance.	
3	LOinput	_	2.1	Local input pin. Recommended input level is -10 to 0 dBm.	
5	Vcc	2.7 to 3.3	-	Supply voltage pin.	
6	RFoutput	Same bias as Vcc through external inductor	_	This pin is the RF output from the double balanced mixer. This pin is designed as an open collector. Due to the high impedance output, this pin should be externally equipped with an LC matching circuit to the next stage.	

### **PIN FUNCTIONS** (Pin Voltage is measured at Vcc = VPs = VRFOUT = 2.8V)

<sup>2.</sup> Mounted on a double-sided copper clad 50x50x1.6 mm epoxy glass PWB,  $T_A = +85^{\circ}C$ .

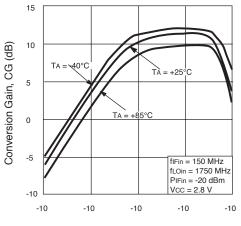
### **TYPICAL PERFORMANCE CURVES** (Unless otherwise specified, TA = 25°C)

#### fRFout = 0.83 GHz



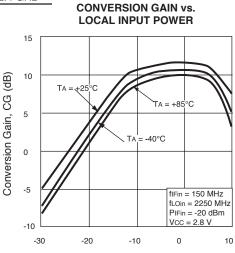


CONVERSION GAIN vs. LOCAL INPUT POWER

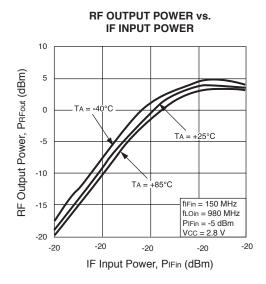


Local Input Power, PLOin (dBm)

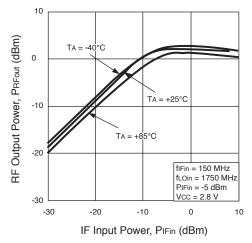
fRFout = 2.4 GHz



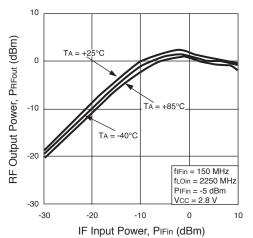




RF OUTPUT POWER vs. IF INPUT POWER

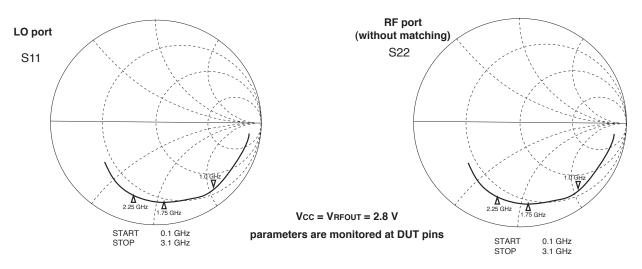


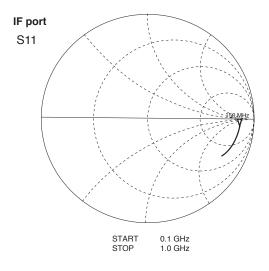
RF OUTPUT POWER vs. IF INPUT POWER



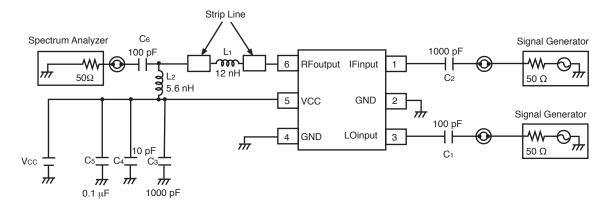
### **UPC8187TB**

## TYPICAL SCATTERING PARAMETERS (TA = 25°C)

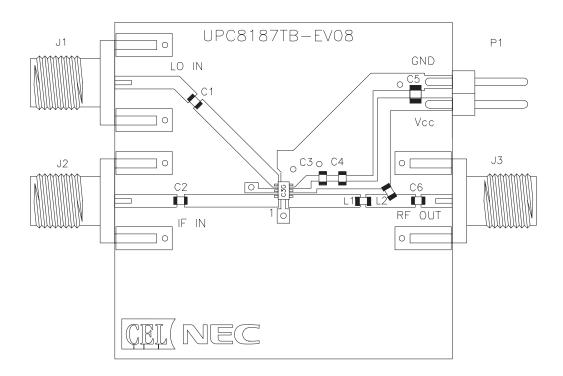




### TEST CIRCUIT 1 (fRFout = 0.83 GHz)



### **ILLUSTRATION OF THE TEST CIRCUIT 1 ASSEMBLED ON EVALUATION BOARD**

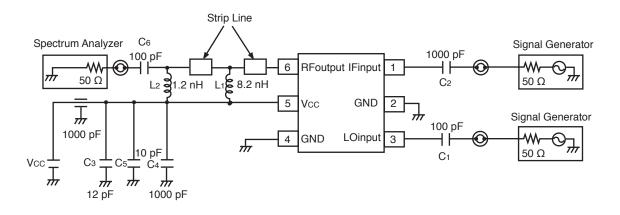


### **COMPONENT LIST**

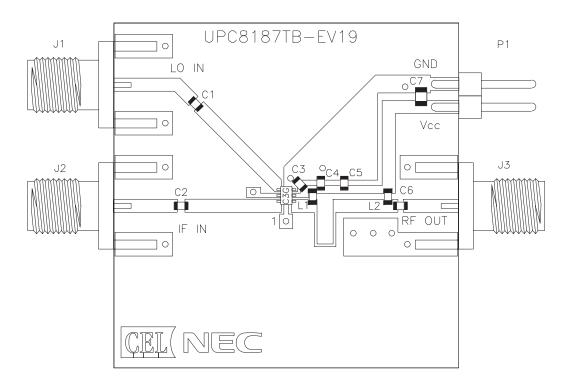
FORM	SYMBOL	VALUE
Chip Capacitor	C1, C6	100 pF
	C4	10 pF
	C2, C3	1000 pF
	C5	0.1µF
Chip Inductor	L1	12 nH
	L2	5.6nH

- 1. 1.5 x 1.5 x 0.028", Getek laminate, double sided copper
- 2. Ground pattern on rear board
- 3. Solder plated patterns
- 4. Through holes

### TEST CIRCUIT 2 (fRFout = 1.9 GHz)



### **ILLUSTRATION OF TEST CIRCUIT 2 ASSEMBLED ON EVALUATION BOARD**

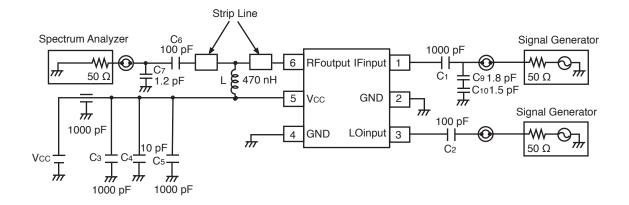


### **COMPONENT LIST**

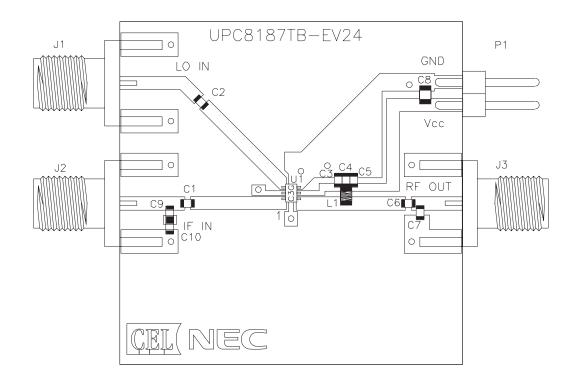
FORM	SYMBOL	VALUE
Chip Capacitor	C1, C2, C4	1000 pF
	C7	0.1μF
	C6	100 pF
	Сз	12 pF
	C5	10 pF
Chip Inductor	L1	8.2 nH
	L2	1.2 nH

- 1. 1.5 x 1.5 x 0.028", Getek laminate, double sided copper
- 2. Ground pattern on rear board
- 3. Solder plated patterns
- 4. Through holes

### TEST CIRCUIT 3 (fRFout = 2.4 GHz)



### **ILLUSTRATION OF TEST CIRCUIT 3 ASSEMBLED ON EVALUATION BOARD**



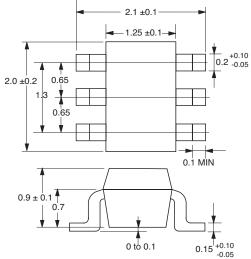
### **COMPONENT LIST**

FORM	SYMBOL	VALUE
Chip Capacitor	C1, C3, C5	1000 pF
	C2, C6	100 pF
	C4	10 pF
	C7	1.2 pF
	C9	1.8 pF
	C10	1.5 pF
Chip Inductor	L	470 nH

- 1. 1.5 x 1.5 x 0.028", Getek laminate, double sided copper
- 2. Ground pattern on rear board
- 3. Solder plated patterns
- 4. Through holes

### OUTLINE DIMENSIONS (Units in mm)

#### PACKAGE OUTLINE S06



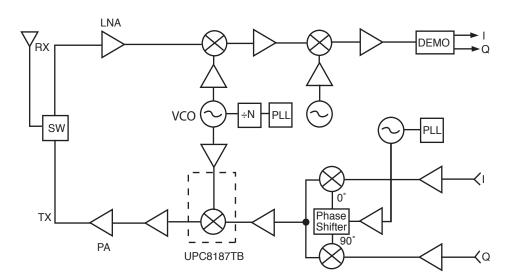
Note: All dimensions are typical unless otherwise specified.

### **ORDERING INFORMATION**

Part Number	Quantity
UPC8187TB-E3-A	3 K pcs/reel

Note: Embossed tape, 8 mm wide. Pins 1, 2 and 3 face the tape perforation side.

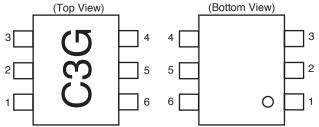
### **SYSTEM APPLICATION EXAMPLE** (Schematic of IC location in the system)



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**PIN CONNECTIONS** 



PIN NO.	PIN NAME
1	IFinput
2	GND
3	LOinput
4	GND
5	Vcc
6	RFoutput

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

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Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentratio in CEL	
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Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB < 1000 PPM		Not Detected	
PBDE	< 1000 PPM	Not Detected	

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